Product data sheet

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NXP Semiconductors



NXP Semiconductors Product specification

Silicon PIN diode BAP70-02

FEATURES

- High voltage, current controlled RF resistor for attenuators
- Low diode capacitance
- · Very low series inductance.

APPLICATIONS

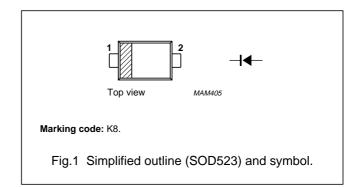
- RF attenuators
- (SAT)TV
- Car radio.

DESCRIPTION

Planar PIN diode in a SOD523 ultra small SMD plastic package.

PINNING

PIN	DESCRIPTION	
1	cathode	
2	anode	



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _R	continuous reverse voltage		_	50	V
I _F	continuous forward current		_	100	mA
P _{tot}	total power dissipation	T _s = 90 °C	_	415	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-65	+150	°C

ELECTRICAL CHARACTERISTICS

 $T_i = 25$ °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V _F	forward voltage	I _F = 50 mA	0.9	1.1	V
I _R	reverse leakage current	V _R = 50 V	_	100	nA
C _d	diode capacitance	V _R = 0 V; f = 1 MHz	570	_	fF
		V _R = 1 V; f = 1 MHz	400	_	fF
		V _R = 5 V; f = 1 MHz	270	_	fF
		V _R = 20 V; f = 1 MHz	200	250	fF
r _D	diode forward resistance	I _F = 0.5 mA; f = 100 MHz	77	100	Ω
		I _F = 1 mA; f = 100 MHz	40	50	Ω
		I _F = 10 mA; f = 100 MHz	5.4	7	Ω
		I _F = 100 mA; f = 100 MHz	1.4	1.9	Ω
τ∟	charge carrier life time	when switched from I_F = 10 mA to I_R = 6 mA; R_L = 100 Ω ; measured at I_R = 3 mA	1.25	_	μs
L _S	series inductance	I _F = 100 mA; f = 100 MHz	0.6	_	nH

NXP Semiconductors Product specification

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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
R _{th j-s}	thermal resistance from junction to soldering point	145	K/W

GRAPHICAL DATA

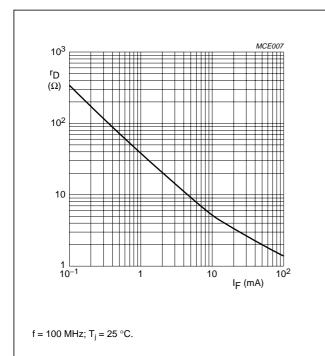


Fig.2 Forward resistance as a function of forward current; typical values.

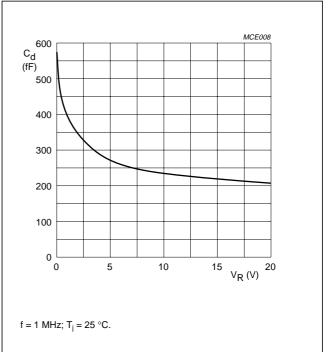


Fig.3 Diode capacitance as a function of reverse voltage; typical values.

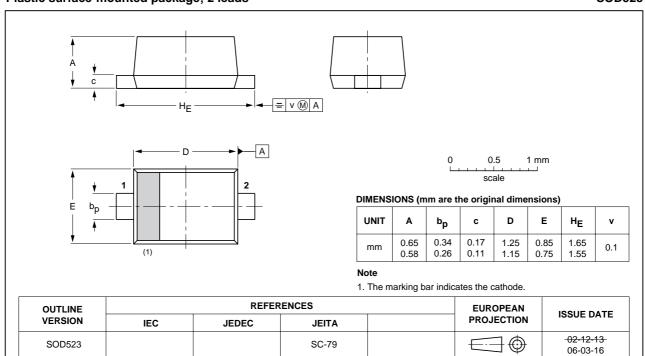
NXP Semiconductors Product specification

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PACKAGE OUTLINE

Plastic surface-mounted package; 2 leads

SOD523



NXP Semiconductors BAP70-02

Silicon PIN diode

Legal information

Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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NXP Semiconductors BAP70-02

Silicon PIN diode

Revision history

Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
BAP70-02_N_5	20080102	Product data sheet	-	BAP70-02_N_4	
Modifications: • Package outline drawing on page 4 changed					
BAP70-02_N_4	20070322	Product data sheet	-	BAP70-02_3	
BAP70-02_3 (9397 750 10093)	20020806	Product specification	-	BAP70-02_N_2	
BAP70-02_N_2 (9397 750 10079)	20020702	Preliminary specification	-	BAP70-02_N_1	
BAP70-02_N_1 (9397 750 09578)	20020402	Preliminary specification	-	-	

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